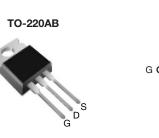
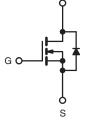


Vishay Siliconix

Power MOSFET

| PRODUCT SUMMARY | | | | | |
|----------------------------|-----------------|------|--|--|--|
| V _{DS} (V) | 500 | | | | |
| R _{DS(on)} (Ω) | $V_{GS} = 10 V$ | 0.28 | | | |
| Q _g (Max.) (nC) | 130 | | | | |
| Q _{gs} (nC) | 33 | | | | |
| Q _{gd} (nC) | 59 | | | | |
| Configuration | Single | | | | |





N-Channel MOSFET

FEATURES

• Low Gate Charge Q_q results in Simple Drive Requirement



- Improved Gate, Avalanche and Dynamic dV/dt RoHS Ruggedness COMPLIANT
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Low t_{rr} and Soft Diode Recovery
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- ZVS and High Frequency Circuit
- PWM Inverters

| ORDERING INFORMATION | |
|----------------------|----------------|
| Package | TO-220AB |
| Lead (Pb)-free | IRFB17N50LPbF |
| | SiHFB17N50L-E3 |
| SnPb | IRFB17N50L |
| | SiHFB17N50L |

| ABSOLUTE MAXIMUM RATINGS (T _C | = 25 °C, un | ess otherwis | se noted) | | |
|--|-------------------------|---|--------------------|------------------|----------|
| PARAMETER | | | SYMBOL | LIMIT | UNIT |
| Drain-Source Voltage | | V _{DS} | 500 | V | |
| Gate-Source Voltage | | | V _{GS} | ± 30 | v |
| Continuous Drain Current | V _{GS} at 10 V | T _C = 25 °C T _C = 100 °C | - I _D | 16 | |
| | | T _C = 100 °C | | 11 | А |
| Pulsed Drain Current ^a | | | I _{DM} | 64 | |
| Linear Derating Factor | | | 1.8 | W/°C | |
| Single Pulse Avalanche Energy ^b | | E _{AS} | 390 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 16 | А |
| Repetitive Avalanche Energy ^a | | | E _{AR} 22 | | mJ |
| Maximum Power Dissipation | T _C = | 25 °C | P _D | 220 | W |
| Peak Diode Recovery dV/dt ^c | | dV/dt | 13 | V/ns | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to + 150 | °C | |
| Soldering Recommendations (Peak Temperature) | for | for 10 s | | 300 ^d | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf ∙ in |
| | | | | 1.1 | N · m |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting $T_J = 25 \text{ °C}$, L = 3.0 mH, $R_g = 25 \Omega$, $I_{AS} = 16 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 16$ A, dI/dt ≤ 347 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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| THERMAL RESISTANCE RATI | NGS | - | | | | | | |
|--|---|---|---|-----------------------|-----------|------|-------|------|
| PARAMETER | SYMBOL | TYP. MAX. | | | UNIT | | | |
| Maximum Junction-to-Ambient | R _{thJA} | - 62 0.50 - - 0.56 | | | | | | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | | | | °C/W | | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | | | | | | | |
| | alaaa athamu | viac noted) | | | | | | |
| SPECIFICATIONS (T _J = 25 °C, u | | 1 | | 10 | N. ALINI | 7/0 | | |
| PARAMETER | SYMBOL | IES | | 15 | MIN. | TYP. | MAX. | UNIT |
| Static | | | 0.1/ 1 050 | | 500 | | | |
| Drain-Source Breakdown Voltage | V _{DS} | | = 0 V, I _D = 250 | • | 500 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | | e to 25 °C, I _D | | - | 0.6 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | | | 3.0 | - | 5.0 | V |
| Gate-Source Leakage | I _{GSS} | $V_{GS} = \pm 30 \text{ V}$ | | | - | - | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | = 500 V, V _{GS} = | | - | - | 50 | μA |
| | $V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 125 \text{ °C}$ | | | - | - | 2.0 | mA | |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 9 | 9.9 A ^b | - | 0.28 | 0.32 | Ω |
| Forward Transconductance | 9 _{fs} | $V_{DS} = 50 \text{ V}, \text{ I}_{D} = 9.9 \text{ A}^{b}$ | | 11 | - | - | S | |
| Dynamic | | | | | | | | - |
| Input Capacitance | C _{iss} | | V _{GS} = 0 V, | | - | 2760 | - | |
| Output Capacitance | C _{oss} | $V_{DS} = 25 V,$ | | - | 325 | - | | |
| Reverse Transfer Capacitance | C _{rss} | t = 1 | f = 1.0 MHz, see fig. 5 | | - | 37 | - | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V$ | $V_{DS} = 1.0 V$, | f = 1.0 MHz | - | 3690 | - | рF |
| | | $V_{GS} = 0 V$ | V _{DS} = 400 V | , f = 1.0 MHz | - | 84 | - | |
| Effective Output Capacitance | Coss eff. | $V_{GS} = 0 V$ | $V_{DS} = 0 V$ | to 400 V ^c | - | 159 | - | |
| Total Gate Charge | Qg | | | | - | - | 130 | |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | $V_{GS} = 10 V$ $I_D = 16 A, V_{DS} = 40$ see fig. 6 and 1 | | - | - | 33 | nC |
| Gate-Drain Charge | Q _{gd} | | | | - | - | 59 | |
| Turn-On Delay Time | t _{d(on)} | | | | - | 21 | - | |
| Rise Time | t _r | V _{DD} = 250 V, I _D = 16 A, | | - | 51 | - | 1 | |
| Turn-Off Delay Time | t _{d(off)} | | $R_{g} = 7.5 \Omega$, see fig. 10 ^b | | - | 50 | - | ns |
| Fall Time | t _f | 1 | | - | 28 | - | 1 | |
| Drain-Source Body Diode Characteristic | S | | | | | | | 1 |
| Continuous Source-Drain Diode Current | ۱ _S | MOSFET sym | bol | | - | - | 16 | |
| Pulsed Diode Forward Current ^a | I _{SM} | showing the integral reverse p - n junction diode | | - | - | 64 | A | |
| Body Diode Voltage | V _{SD} | T _J = 25 °C, I _S = 16 A, V _{GS} = 0 V ^b | | - | - | 1.5 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | $T_J = 25 \text{ °C}$ $T_J = 125 \text{ °C}$ | | - | 170 | 250 | ns | |
| | | | | - | 220 | 330 | | |
| Body Diode Reverse Recovery Charge | Q _{rr} | - | $I_{\rm J} = 25 ^{\circ}{\rm C}$ $I_{\rm F} = 16 \text{A}, dI/dt = 100 \text{A}/\mu\text{s}^{\rm b}$ | | - | 470 | 710 | nC |
| | | T _J = 125 °C | 1 | - | 810 | 1210 | | |
| Reverse Recovery Current | I _{RRM} | | | | - | 7.3 | 11 | А |
| Forward Turn-On Time | t _{on} | Intrincia tu | ırn-on time is r | egligible (turn | on is dor | | | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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V_{DS} = 50 V

8.0

20 µs PULSE WIDTH

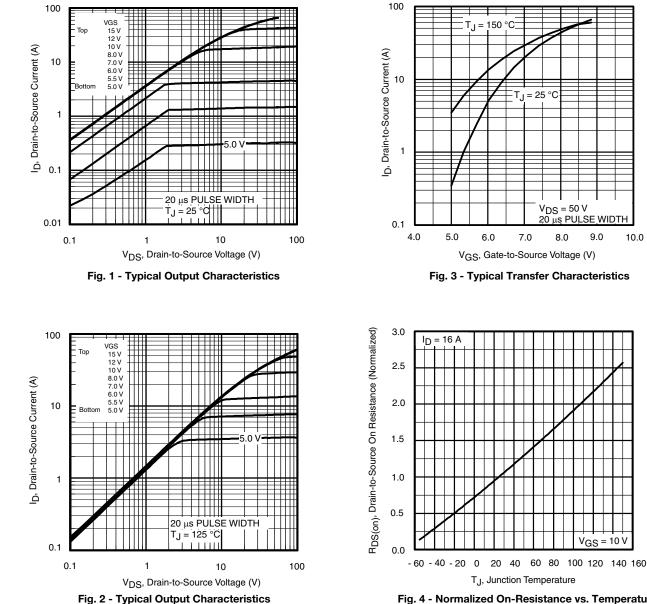
9.0

VGS

10 V

10.0

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 4 - Normalized On-Resistance vs. Temperature

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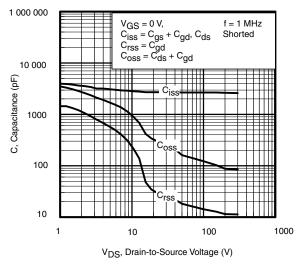
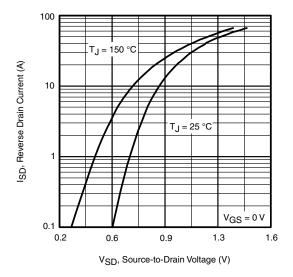


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





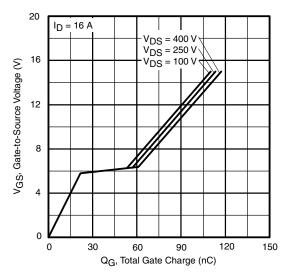


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

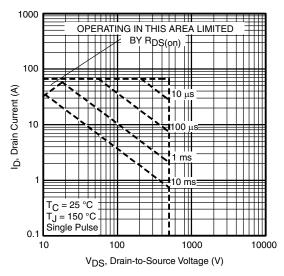


Fig. 8 - Maximum Safe Operating Area

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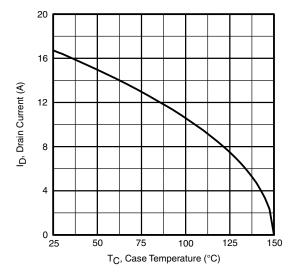


Fig. 9 - Maximum Drain Current vs. Case Temperature

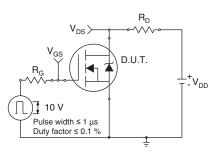


Fig. 10a - Switching Time Test Circuit

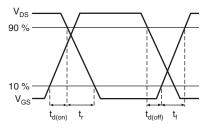


Fig. 10b - Switching Time Waveforms

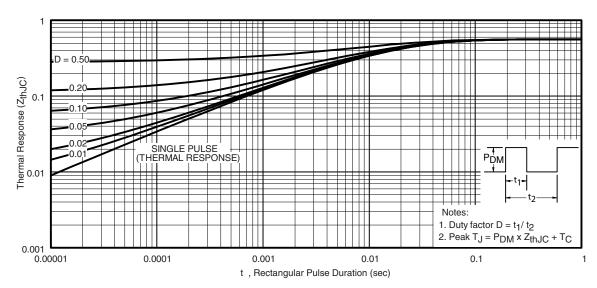


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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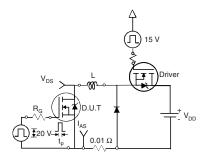


Fig. 12a - Unclamped Inductive Test Circuit

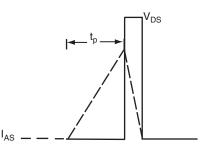


Fig. 12b - Unclamped Inductive Waveforms

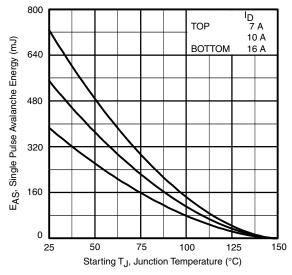


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

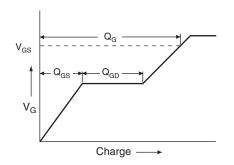


Fig. 13a - Basic Gate Charge Waveform

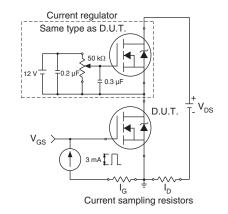
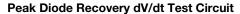


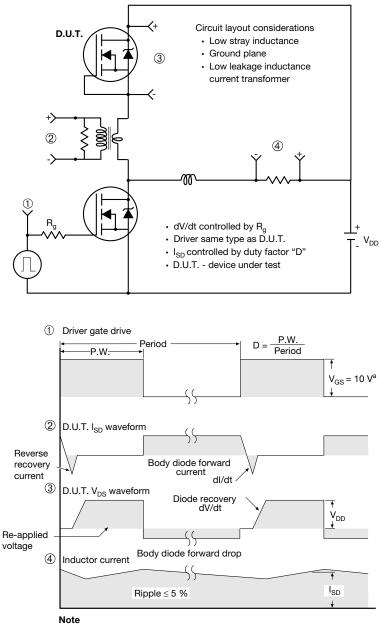
Fig. 13b - Gate Charge Test Circuit

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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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